

N-channel TrenchMOS standard level FET

Rev. 02 — 3 February 2009

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

### 1.2 Features and benefits

- Higher operating power due to low thermal resistance
- Low conduction losses due to low on-state resistance
- Simple gate drive required due to low gate charge
- Suitable for high frequency applications due to fast switching characteristics

### 1.3 Applications

DC-to-DC convertors switching

#### 1.4 Quick reference data

Table 1.	Quick reference					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	200	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> ; see <u>Figure 3</u>	-	-	32.7	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	230	W
Dynamic	characteristics					
Q <sub>GD</sub>	gate-drain charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \ V; \ I_D = 25 \ A; \\ V_{DS} = 100 \ V; \ T_j = 25 \ ^\circ C; \\ \text{see} \ \underline{Figure \ 11} \end{array}$	-	9.6	-	nC
Static ch	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 15 \text{ A}; \\ T_{j} = 25 \ ^{\circ}\text{C}; \text{ see } \underline{\text{Figure 9}}; \\ \text{see } \underline{\text{Figure 10}} \end{array}$	-	65	77	mΩ

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# 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S
			SOT78 (TO-220AB;SC-46)	

# 3. Ordering information

#### Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PHP33NQ20T	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

#### **Limiting values** 4.

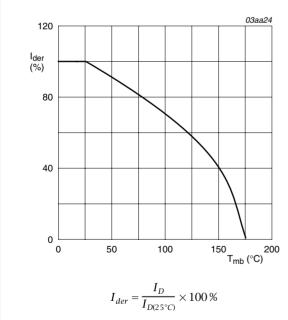
#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

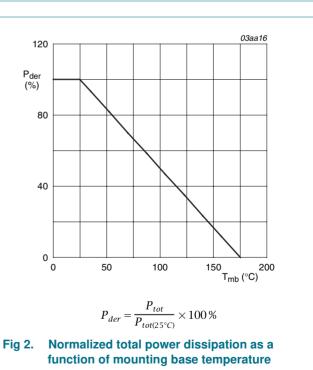
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	200	V
V <sub>DGR</sub>	drain-gate voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C; R <sub>GS</sub> = 20 kΩ	-	200	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	-	23.1	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u> ; see <u>Figure 3</u>	-	32.7	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	65.4	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	230	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	rain diode				
Is	source current	T <sub>mb</sub> = 25 °C	-	32.7	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	65.4	А
Avalanche	es ruggedness				
$E_{DS(AL)S}$	non-repetitive drain-source avalanche	$V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; I_D = 10.4 \text{ A}; V_{sup} \le 200 \text{ V};$ unclamped; $t_p = 0.14 \text{ ms}; R_{GS} = 50 \Omega$	-	190	mJ

energy

drain-source avalanche unclamped;  $t_p = 0.14 \text{ ms}$ ;  $R_{GS} = 50 \Omega$ 



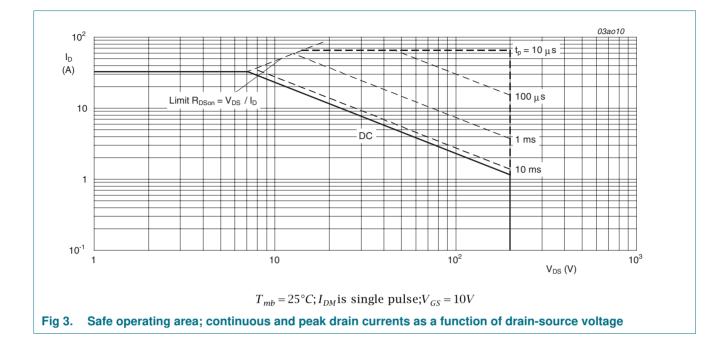
Normalized continuous drain current as a Fig 1. function of mounting base temperature



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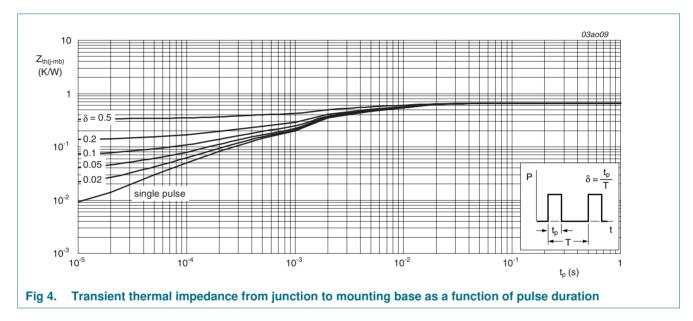
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PHP33NQ20T



# 5. Thermal characteristics

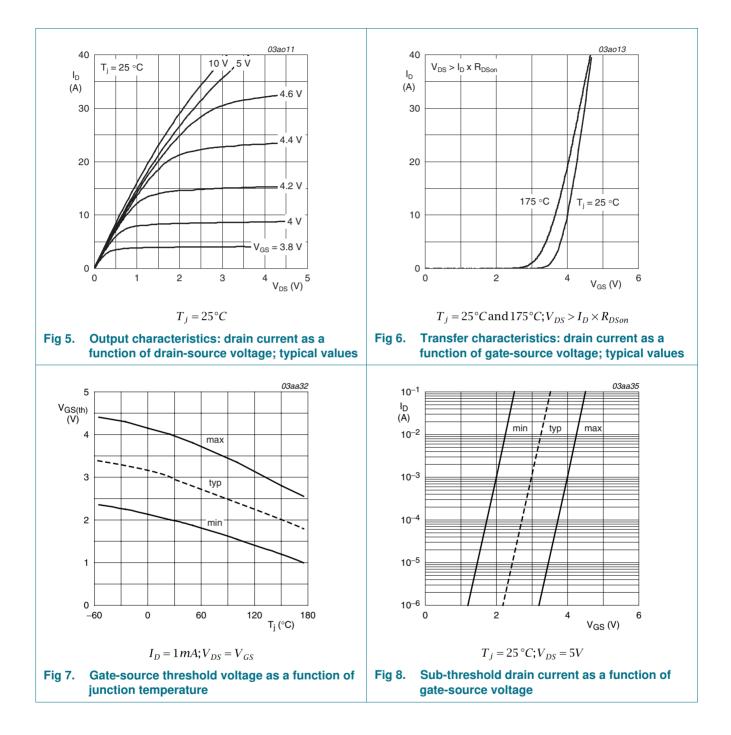
Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see Figure 4	-	-	0.65	K/W



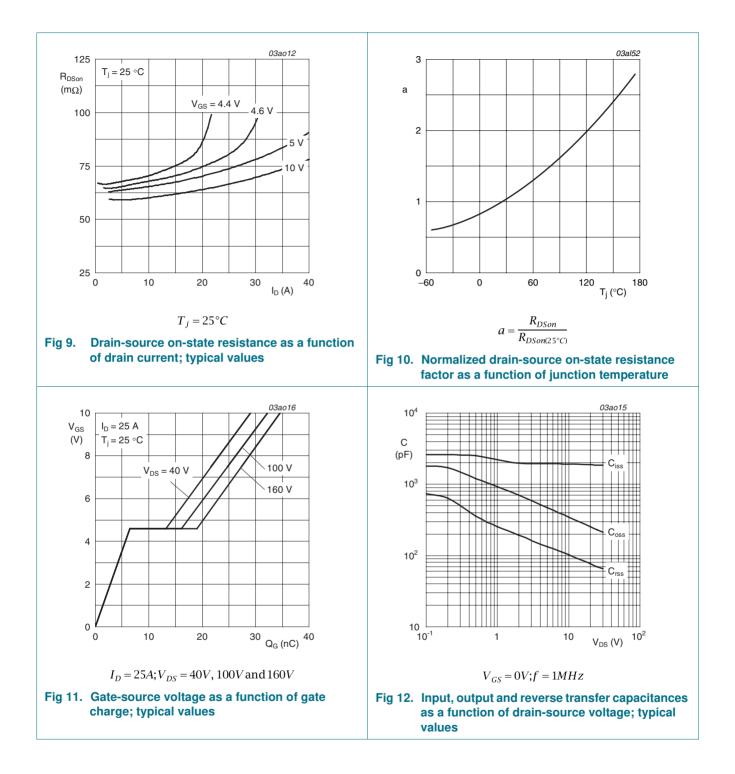
# 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
(BH)000	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$	180	-	-	V
	breakdown voltage	$I_{D} = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_{j} = 25 \ ^{\circ}C$	200	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 7</u> ; see <u>Figure 8</u>	1	-	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; see <u>Figure 7</u> ; see <u>Figure 8</u>	2	3	4	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; see <u>Figure 7</u> ; see <u>Figure 8</u>	-	-	4.4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 160 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C	-	-	500	μA
		$V_{DS}$ = 160 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	10	100	nA
		$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	10	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 10 V; $I_D$ = 15 A; $T_j$ = 25 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	-	65	77	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	-	182	215	mΩ
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 100 \text{ V}; V_{GS} = 10 \text{ V};$	-	32.2	-	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	6.5	-	nC
Q <sub>GD</sub>	gate-drain charge		-	9.6	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = 25 V; V_{GS} = 0 V; f = 1 MHz;$	-	1870	-	рF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 12</u>	-	230	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	70	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 100 \; V; \; R_L = 4 \; \Omega; \; V_{GS} = 10 \; V; \;$	-	12	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \ \Omega; T_j = 25 \ ^{\circ}C$	-	35	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	43	-	ns
t <sub>f</sub>	fall time		-	45	-	ns
Source-d	rain diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	0.87	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_S=20~A;~dI_S/dt=-100~A/\mu s;~V_{GS}=0~V;$	-	150	-	ns
Qr	recovered charge	V <sub>DS</sub> = 25 V; T <sub>j</sub> = 25 °C	-	645	-	nC

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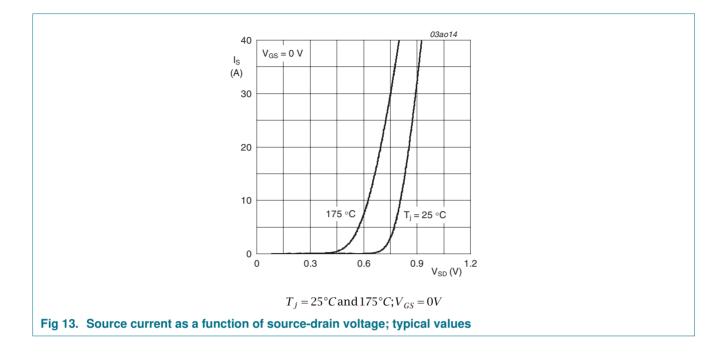


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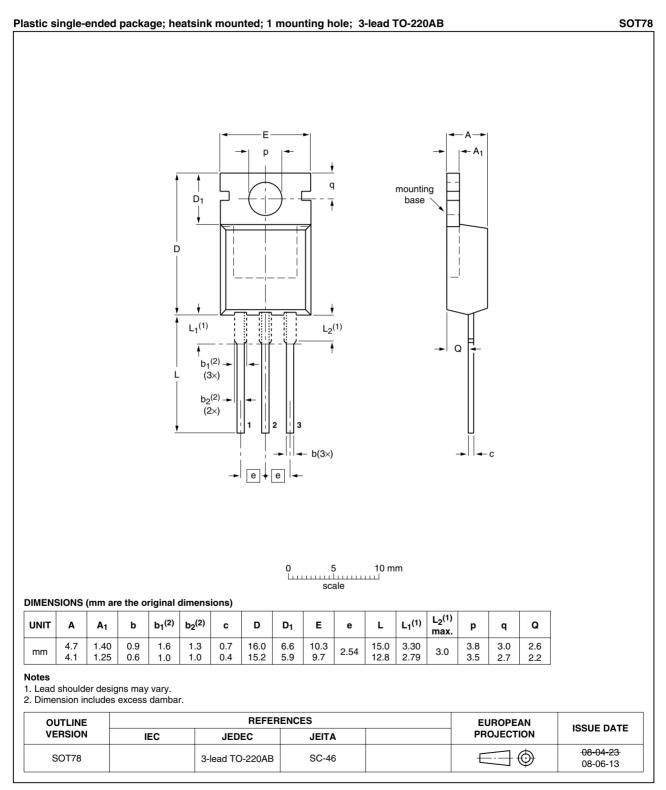


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# PHP33NQ20T N-channel TrenchMOS standard level FET



# 7. Package outline



#### Fig 14. Package outline SOT78 (TO-220AB)

# 8. Revision history

Table 7. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PHP33NQ20T_2	20090203	Product data sheet	-	PHP_PHB33NQ20T_1
Modifications:		of this data sheet has bee of NXP Semiconductors.	n redesigned to comply	with the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	new company name wh	ere appropriate.
PHP_PHB33NQ20T_1 (9397 750 14003)	20041108	Product data sheet	-	-

# 9. Legal information

#### 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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